

MINILOCK-PHANTOM III

Reactive Ion Etcher (RIE) with a Vacuum Loadlock

The Minilock-Phantom III is the first plasma RIE system in the industry to incorporate a vacuum loadlock on a compact platform. The system meets all the safety and equipment needs for the most challenging etch processes including applications that require corrosive chemistries.

Applications

Because metal and compound semiconductor etch processes use corrosive chemistries and are often sensitive to atmospheric moisture, consistent results as well as safety depend upon isolating the reaction chamber from the atmosphere. In addition, when operating at lower pressure, maintaining reproducible results from run to run is impacted when the chamber is exposed to the atmosphere between each run. The Minilock-Phantom III solves these issues with its fully integrated loadlocked delivery system.





Tool Features

Reactor

The cathode and anode are each machined out of single blocks of aluminum. After critical inspection they are hard anodized for protection from process chemistries. The bottom electrode is available in either 200mm or 300mm sizes and depending on electrode configuration, can process single wafers or mounted parts (3" - 300mm). It also has multiple size batch capability (4x3"; 3x4"; 7x2"). Process gases are introduced into the chamber either by an annular ring or a showerhead manifold.

Automatic Matchina Network

The uniquely designed network is built in as an integral part of the bottom electrode assembly to ensure accurate tuning, low transmission loss and virtually no RF radiation outside the network itself. The network uses a phase magnitude sensor and amplifiers to provide instantaneous feedback for quick precise tuning.

Vacuum Loadlock

Trion's vacuum loadlocked system includes compatible robotic arm, reactor isolation valve and locked chamber. The robotic arm has a direct drive pick and place mechanism that provides high reliability.

RF Generator The system comes with a 600 watt, 13.56 MHz solid state RF generator.

Operator Interface

Touch Screen A color flat panel display with touch screen interface provides the operator with full process information at all times. The software interface guides the operator through each sequence in a logical fashion and gives fingertip control of all process parameters.

PC Process Controller

The PC process controller provides simple and reliable system control. The graphical software package creates programs in block diagram form. Process recipes are stored on the hard drive or can be stored on USB flash drives allowing each operator to maintain individual recipes.

AC Distribution Module

The AC distribution module automatically distributes predefined power quantities to the various internal components. When the Emergency Power Off button is tripped, the RF power is shut off and all valves involved with gas delivery are automatically closed and the machine powers down to a safe standby mode. This system includes separate power controls for the main AC and peripherals.

Automatic Pressure Control

The system includes a butterfly pressure control valve operated directly by the process controller. This provides independent pressure control separate from all other process parameters.

Gas Delivery System

State-of-the-art technology is utilized to ensure the utmost integrity and purity. Each reaction chamber accommodates up to eight mass flow controllers and all plumbing utilizes surface mount, C-seal technology or orbital welded VCR fittings.

Safety

The system meets SEMI S2-93 safety requirements. The system is CE compliant with Machinery Directive 98/37/EC, the Low Voltage Directive 73/23/EEC and the Electromagnetic Compatibility Directive 89/336/EEC for CE Marking requirements. A third party safety review is available upon request.

Facilities

Facility schematics can be provided upon request.

Advanced Options

Custom Gas Cabinets

Trion provides remote gas cabinets with self-closing doors which house gas delivery and nitrogen purging for toxic or corrosive gases controlled by the on-board computer. The system automatically purges the process supply lines with nitrogen when the system is placed in standby mode. This extends the life of the mfc's, regulators, valves and associated plumbing. The gas cabinets include regulators for toxic or dangerous gases such as chlorine, silane and ammonia. Included are automatic "at-thebottle" shut off valves and stainless steel lecture bottle holders.

Pumping Systems

Each reaction chamber requires it's own pump. Trion can supply these as needed according to your requirements. There are mechanical, dry and turbo pump options available. You may choose to provide your own pump(s) or they can be purchased directly from Trion. All pump options provided by Trion are proven systems chosen to best meet your specific process needs



Minilock-Phantom III RIE with ICP option

Control

Temperature An external chiller or heater/chiller may be recommended. By controlling the reactor temperature (bottom electrode), process reproducibility is greatly enhanced and the etch by-products are more readily volatilized.

Endpoint Detection Systems

Trion offers both optical and laser endpoint detection options which allows the user to measure film thickness changes in-situ during the etch process. These systems are integrated into and controlled by Trion software.

Inductively Coupled Plasma

Trion's carefully engineered ICP is a proven option for applications requiring a downstream, high-density plasma source. It dramatically reduces radiation damage and contamination from RIE sputtering and greatly increases selectivity to other films. It allows for higher plasma densities as power is transferred into the bulk plasma via the magnetic field resultant from inductive coupling. This enables processing at lower pressure, which has a number of significant benefits. It allows for tight anisotropy in high aspect ratio structures and reduces microloading effect. Trion's ICP source will result in improved etch rates, profile control, uniformity and selectivity with a dramatic reduction in RIE radiation damage. The ICP comes with a 600 or 1250 watt, 13.56 MHz power supply and a built in automatic matching network.

Electrostatic Chuck

Maintaining cooler substrate temperatures during etching is often critical. Trion's electrostatic chuck holds the wafer securely to the chuck by electrostatic forces while flowing a small quantity of helium onto the backside of the wafer, providing significant

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